

TECHNICAL DATA SHEET



DIC PSAs
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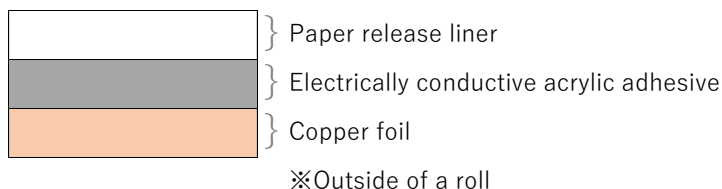


4F50A4 E Color & Comfort

Electrically conductive copper foil adhesive tape

DAITAC® E65CU

■ Construction



■ Characteristics

- ✓ Tape thickness is 65 μm .
- ✓ Excellent electrical conductivity in thickness direction.
- ✓ Excellent adhesion
- ✓ Does not use substances(Toluene etc.) listed in the "Indoor Concentration Guidelines for Chemical Substances" formulated by the Ministry of Health, Labour and Welfare of Japan.
- ✓ Product does not use the 6 restrictive substances of the RoHS Directive.

■ Applications

- ✓ For EMI shielding of electronic equipment.

■ Properties

Test item	Condition	Substrate	Unit	E65CU
Thickness	Except release liner	-	μm	65
180 deg. peel strength	23°C, 1hr	SUS (hairline)	N/25mm	12.8
		PC	N/25mm	11.8
Electrical resistance	Pressure method	Copper foil	$\Omega/6.25\text{cm}^2$	0.01
	Attached method	Copper foil	$\Omega/6.25\text{cm}^2$	0.03
Static shear	70°C, 0.5kg	SUS (hairline)	hr	24 <

■ Size 1,000mm in max width 50m in length

DIC Corp.

Composite Materials Product Div.

https://www.dic-global.com/en/products/adhesive_tapes

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